

Hardware Security Conference

Keynote Content

Prepared For:

hardwear.io
Hardware Security Conference and Training

Cryptography
Research at
Rambus

Presenter: Scott Best
31 May 2024

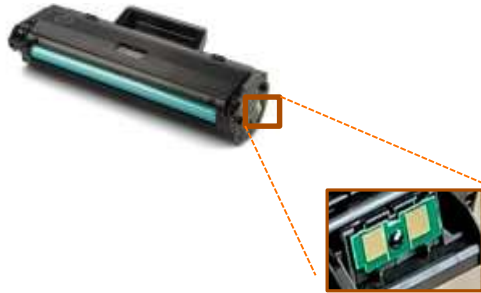
Introduction to Me

- Mixed-Signal Circuit Engineer
 - Most interesting thing I ever built: chaotic TRNG
 - sbest@cryptography.com
- Arrived in Silicon Vally in 1989
- Joined Rambus in 1998
 - PlayStation 3
 - Rambus Labs
 - Cryptography Research subsidiary
- Engineering -> Product Management
 - Anti-Counterfeiting
 - U.S. Defense

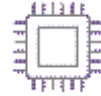


<https://www.linkedin.com/in/scottcbest/>

Today's Talk: reverse-engineering vs. "forward-engineering"

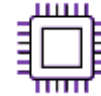


Product
Concept



Forward Engineering

Original
Product



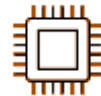
Motivations to prevent R.E.:

- Revenue
- Brand Protection
- Product Safety
- National Defense

Motivations to succeed at R.E.:

- *LOTS* of Revenue
- ~~Brand Protection~~
- ~~Product Safety~~
- National Defense
- Design Recovery

Compatible
Product



Reverse Engineering*

** Overloaded term*



~\$30B market

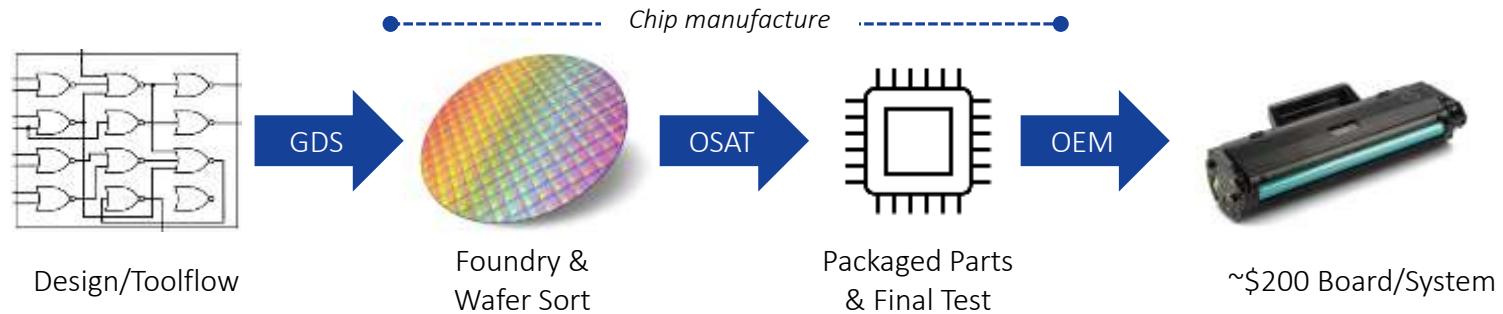


~\$10B market



~\$20B market

Forward Talk: How Security Chips Are Built

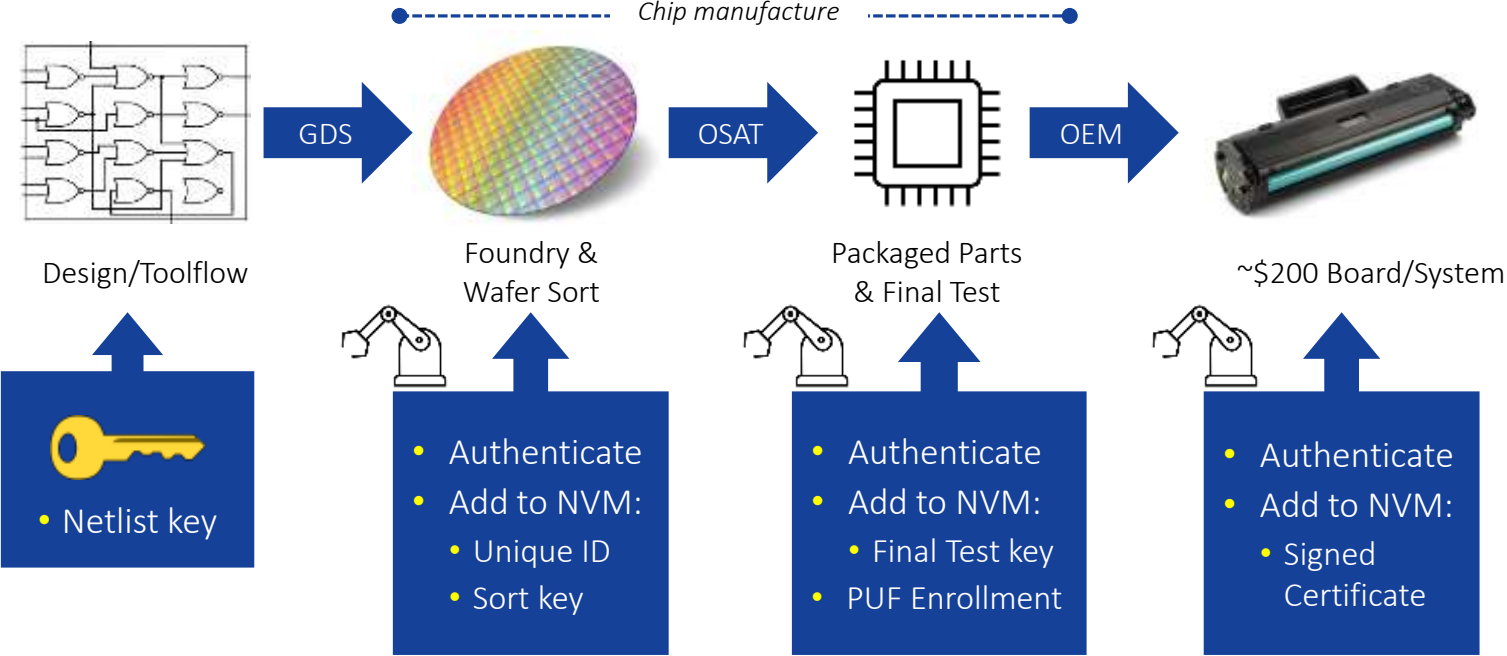


- A 300mm wafer has about 70k mm² of useable area
- A state-of-the-art authentication chip is about 2.5 mm²
 - Each wafer: 28,000 die; each wafer lot: 25 wafers
 - SAM value of one wafer lot: \$140M



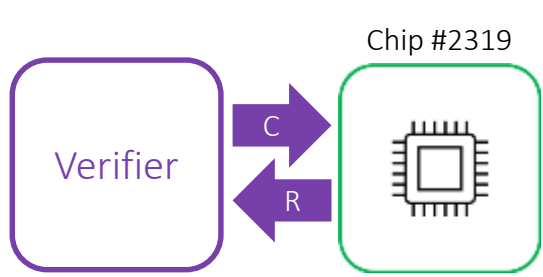
Reverse Talk: Don't Overthink It ... Start with "Basic Theft"

Forward Talk: Supply Chain Security is Essential



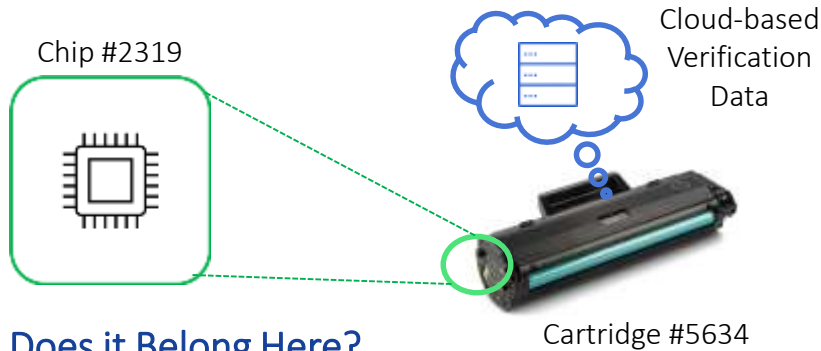
Reverse Talk: Next easiest: Recover Discards, Re-Manufacture Them

Forward Talk: Secure Provenance Defeats Remanufacture



1. Is this Chip Authentic?

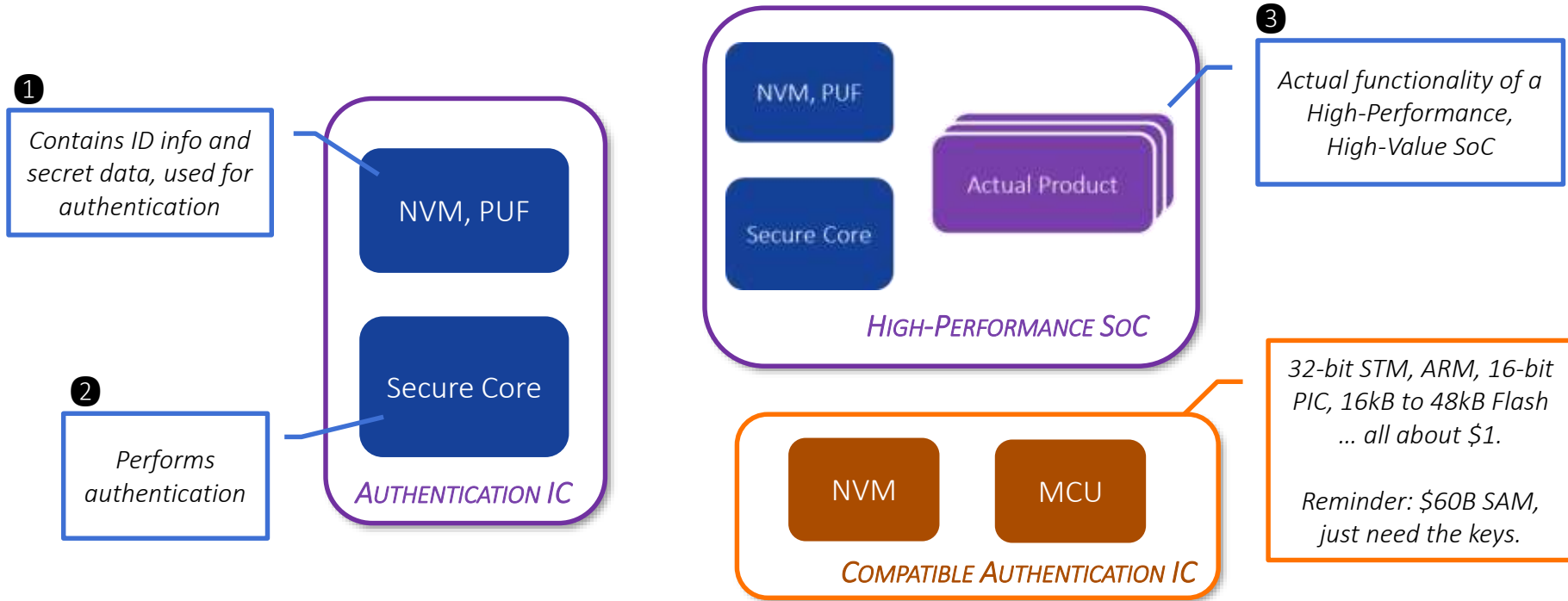
- Authenticity questions can be answered with a Verifier., e.g., an SoC on the same board, a chiplet in the same MCM, an HSM attached during manufacture, etc.
- A chip alone can't tell you if it's been stolen or remanufactured (potentially after malicious modification)



2. Does it Belong Here?

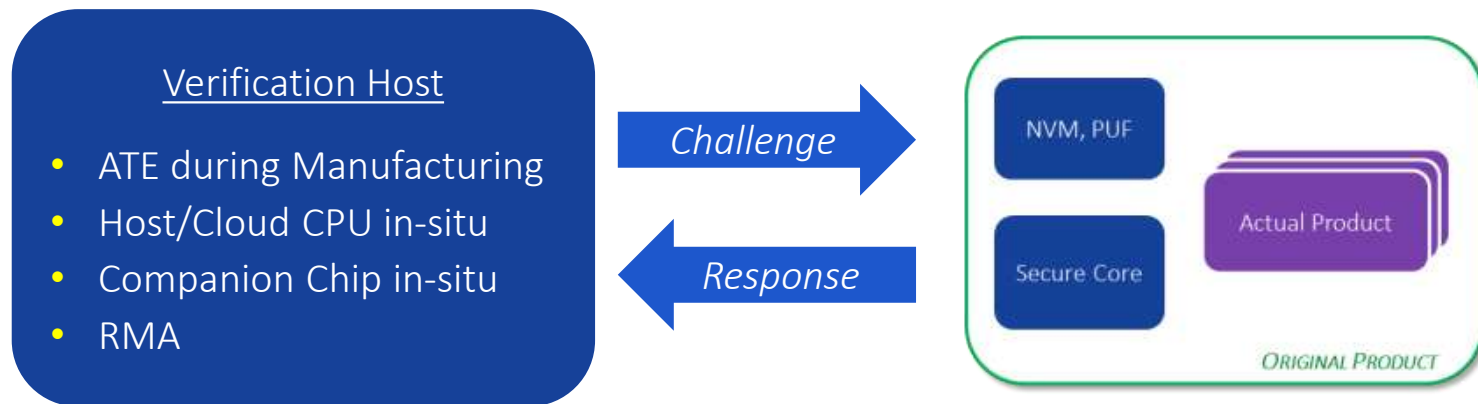
- The “Provenance” of a chip can be tracked by the same secure manufacturing system that provisioned the key material
- If that provenance info is available to the verifier (e.g., secure cloud), stolen or remanufactured chips can be detected
- *Difficult at large commercial scale*

Forward Talk: Backing up ... How to Secure Authentic Chips?



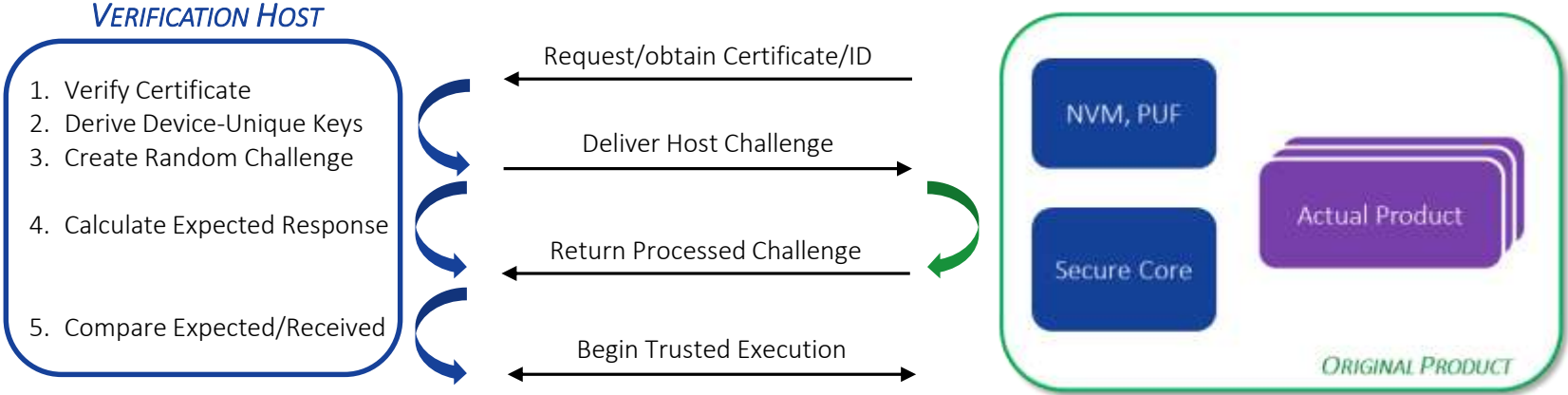
Reverse Talk: How to Obtain Key Material for a Clone or Compatible?

Forward Talk: Practical Magic to Protect Authentication



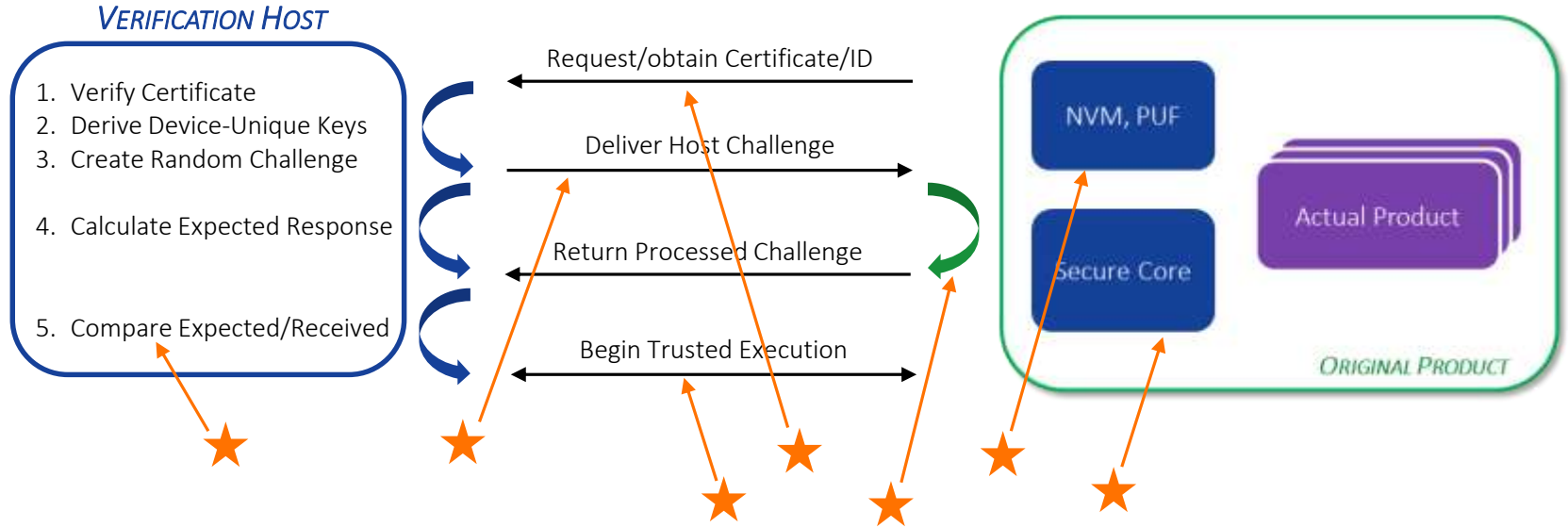
Reverse Talk: Authentication has Many Attack Surfaces

Forward Talk: Authentication Basics



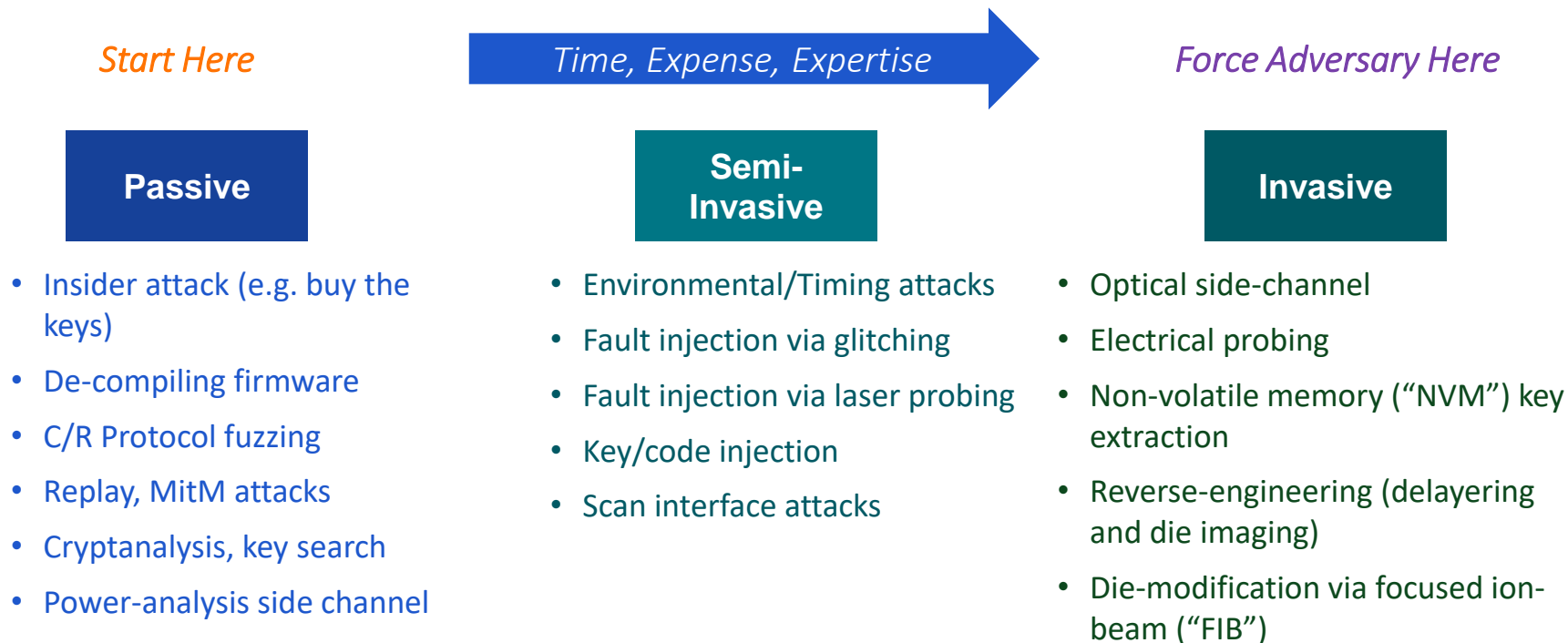
Reverse Talk: Choose Attack Surface optimized for Time/Money

Forward Talk: Authentication Basics



Reverse Talk: Choose Attack Surface optimized for Time/Money

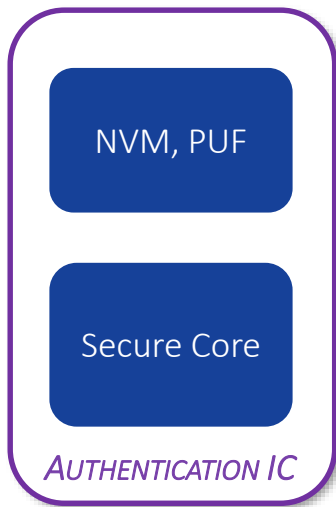
Forward Talk: Attack Surfaces to Worry About



Reverse Talk: Attack Surfaces to Embrace and Deploy

Forward Talk: Technologies I choose to Not Talk About Today...

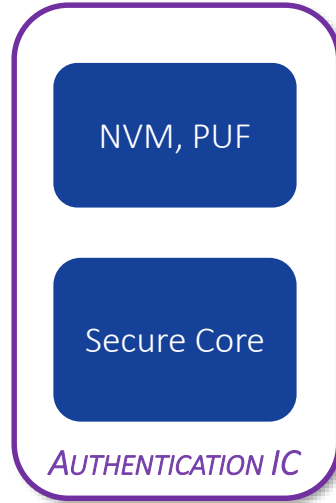
1. DRAM (e.g., RowHammer)
2. Hardware Trojans
3. Laser-Voltage Probing (LVP)
4. Anti-tamper Sensors
5. Camouflage Logic
6. Logic Locking



Reverse Talk: Many “Countermeasures” Assume Unmotivated Attackers

Forward Talk: Technologies To Talk About

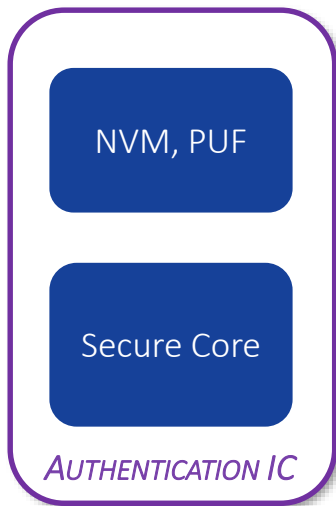
1. Verifiable Provenance ✓
2. Power-Analysis Side-Channel
3. Mutual Authentication
4. Proof-of-Work 2FA
5. Protected NVM
6. Weak PUFs
 - When used correctly
7. Strong PUFs
 - Tamper-evidence



Reverse Talk: Attack Surfaces Exist in the Gaps

Forward Talk: State-of-the-Art Practical Magic

1. Verifiable Provenance ✓
2. Power-Analysis Side-Channel
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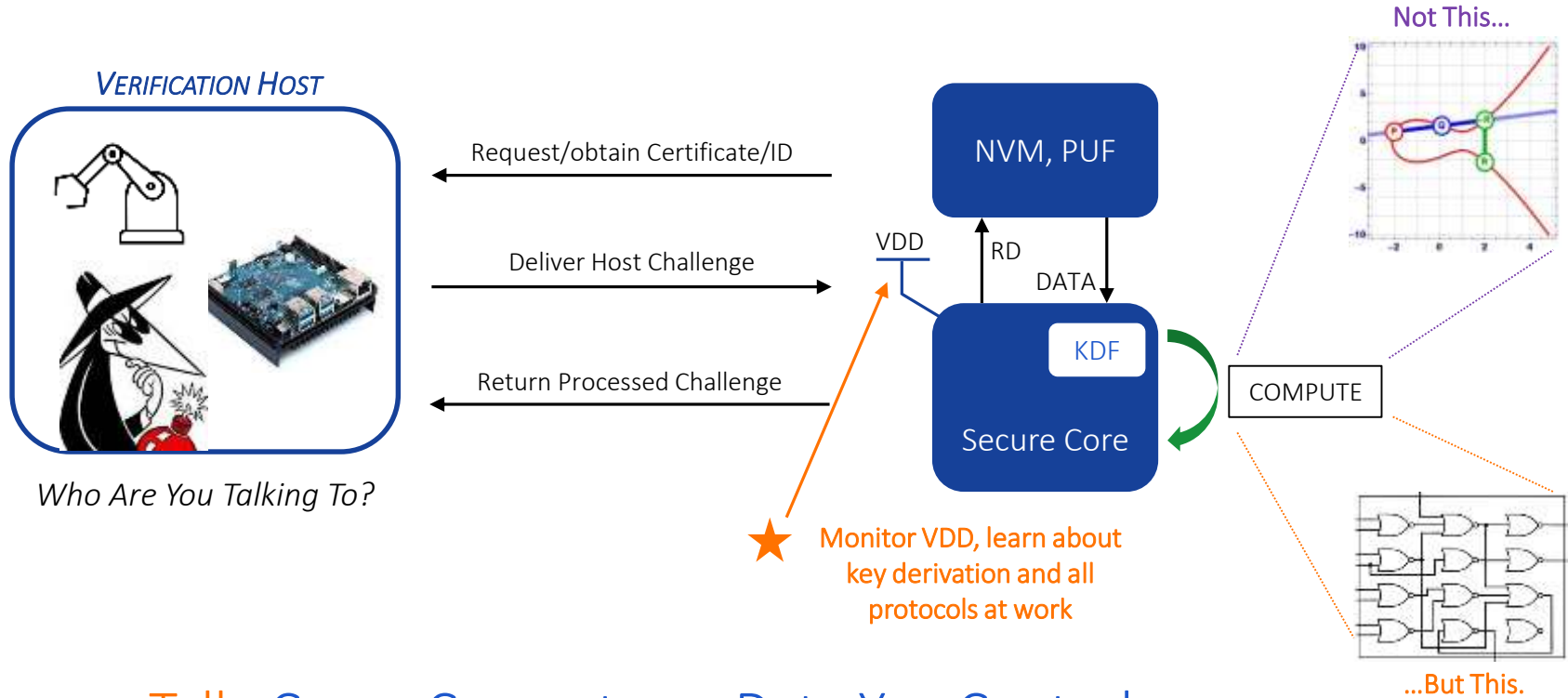


Keep in Mind the Goals:

- Cannot prevent R.E. in general, can only prevent rapid, easily affordable R.E.
- Force your opponent to a **full netlist recovery** with lots of FIBs and **manual electrical measurements**
- Force your opponent to **produce custom silicon**, more than an easily programmed MCU

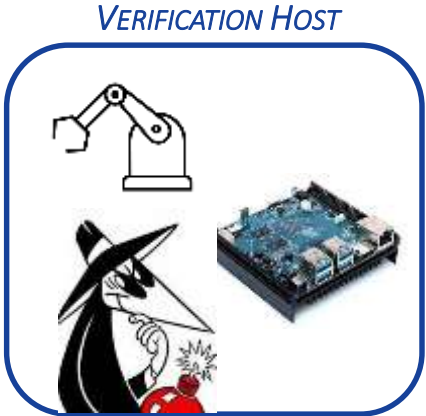
Reverse Talk: Attack Surfaces Exist in the Gaps

Forward Talk: Power-Analysis Side Channel

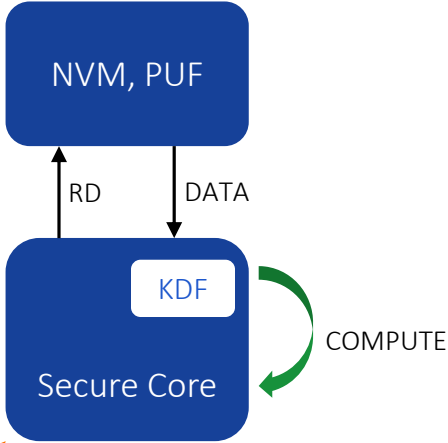
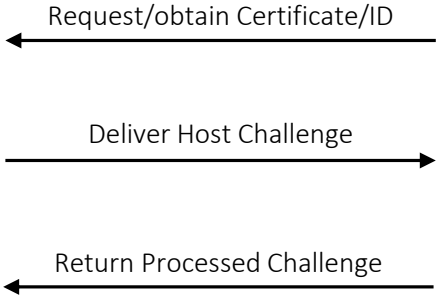


Reverse Talk: Cause Compute on Data You Control

Forward Talk: Mutual Authentication



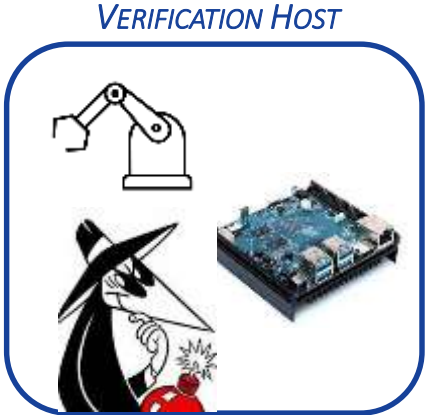
Verifier Must Prove Its Trust



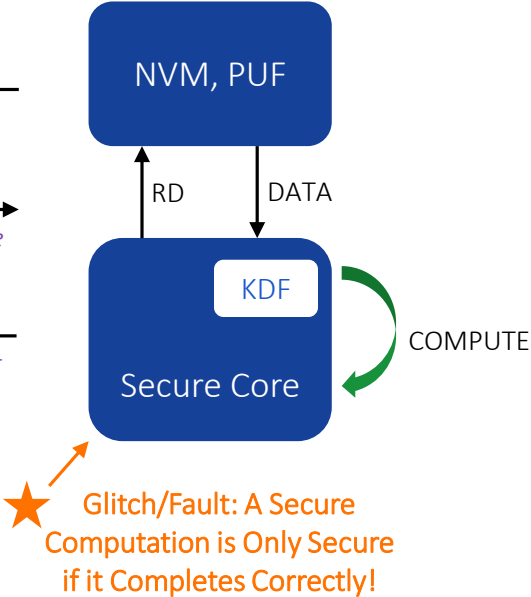
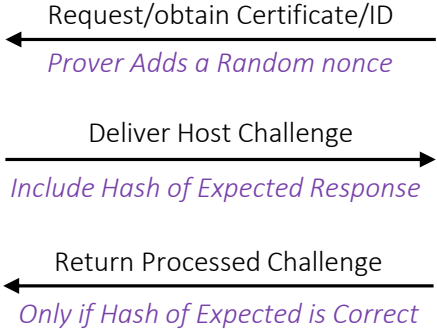
★ Glitch/Fault: A Secure Computation is Only Secure if it Completes Correctly!

Reverse Talk: Cause compute / Harvest Responses to Your Data

Forward Talk: Mutual Authentication

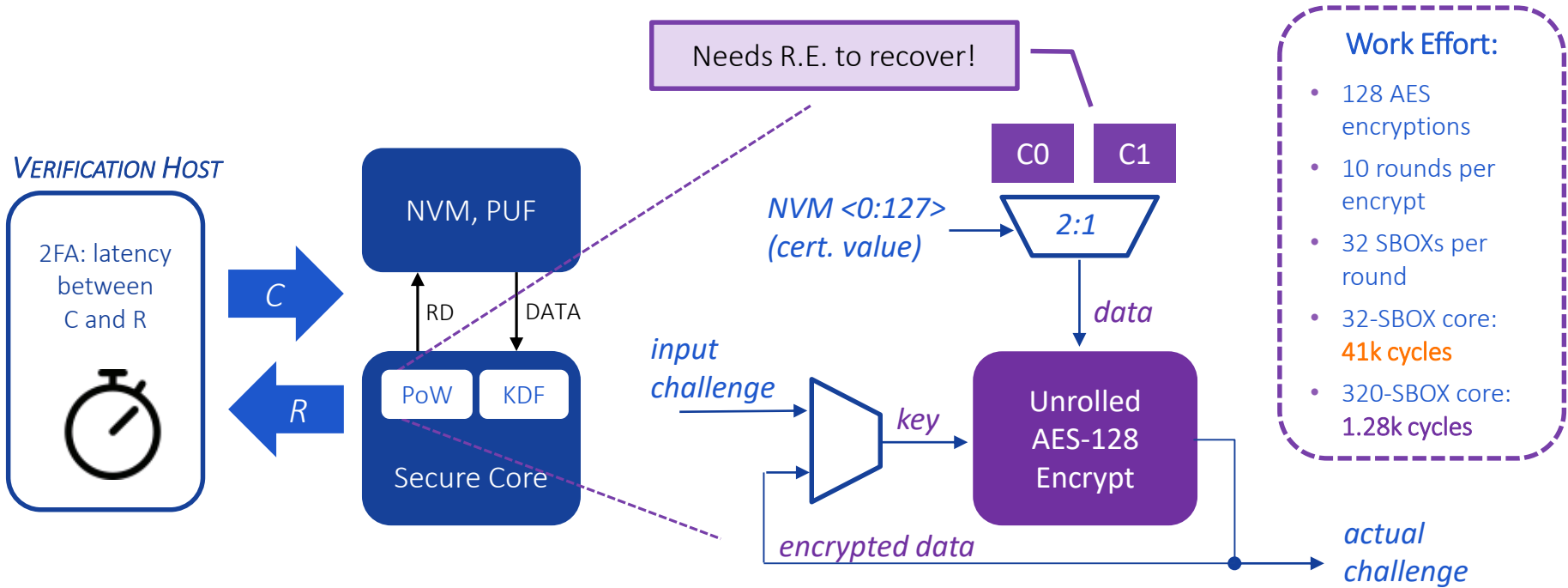


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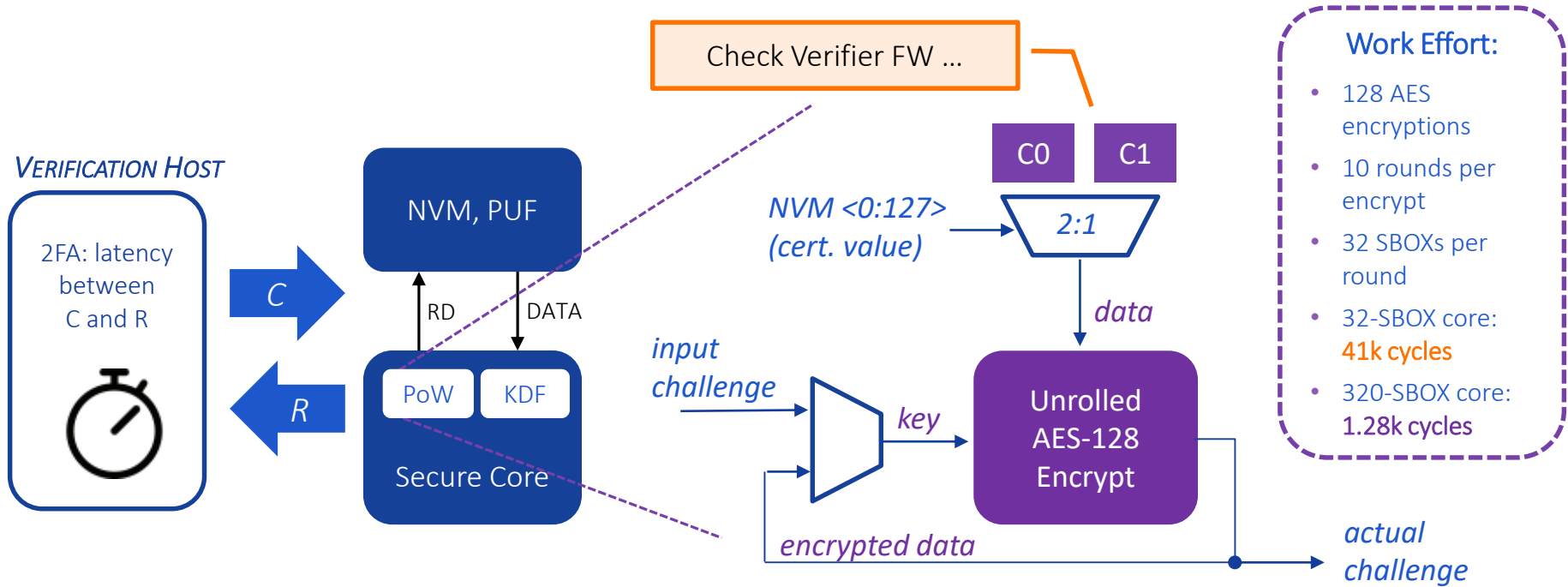
Reverse Talk: Cause compute / Harvest Responses to Your Data

Forward Talk: Proof of Work Can Force Custom Silicon



Reverse Talk: Adjust Clocking if Measured-Timing Matters

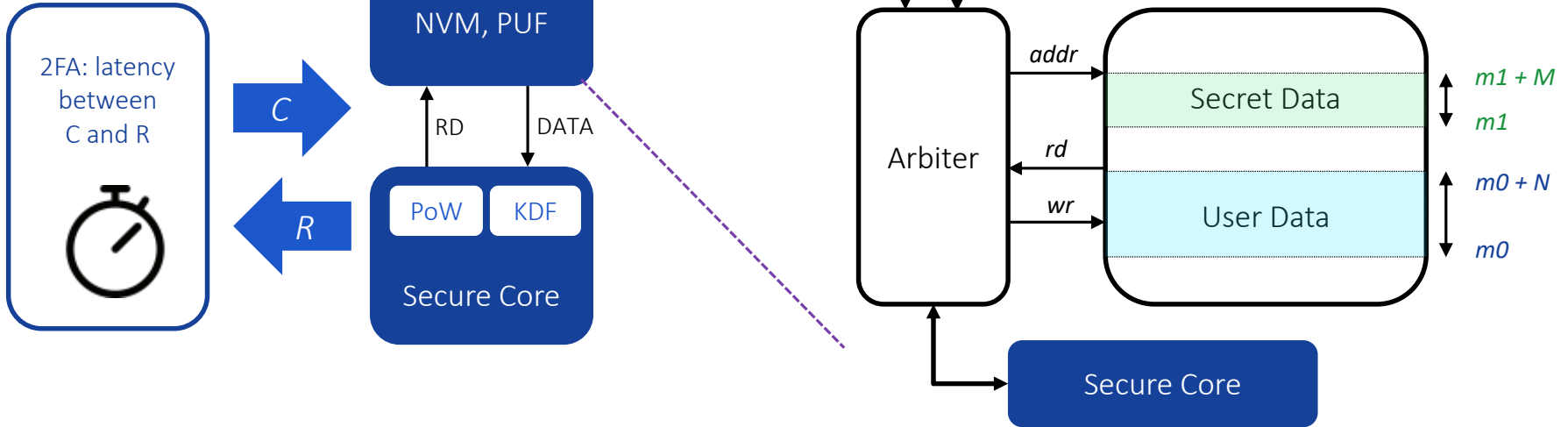
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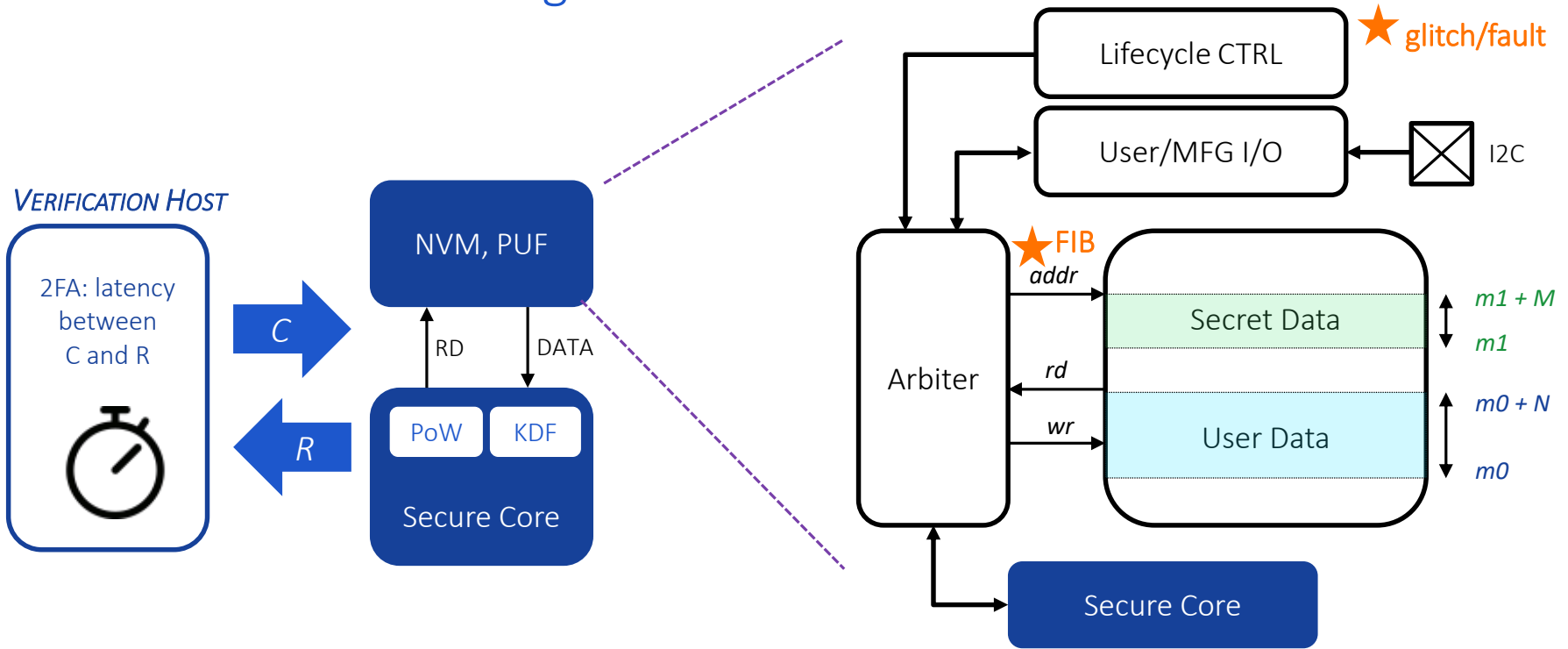
Forward Talk: Protecting NVM

VERIFICATION HOST



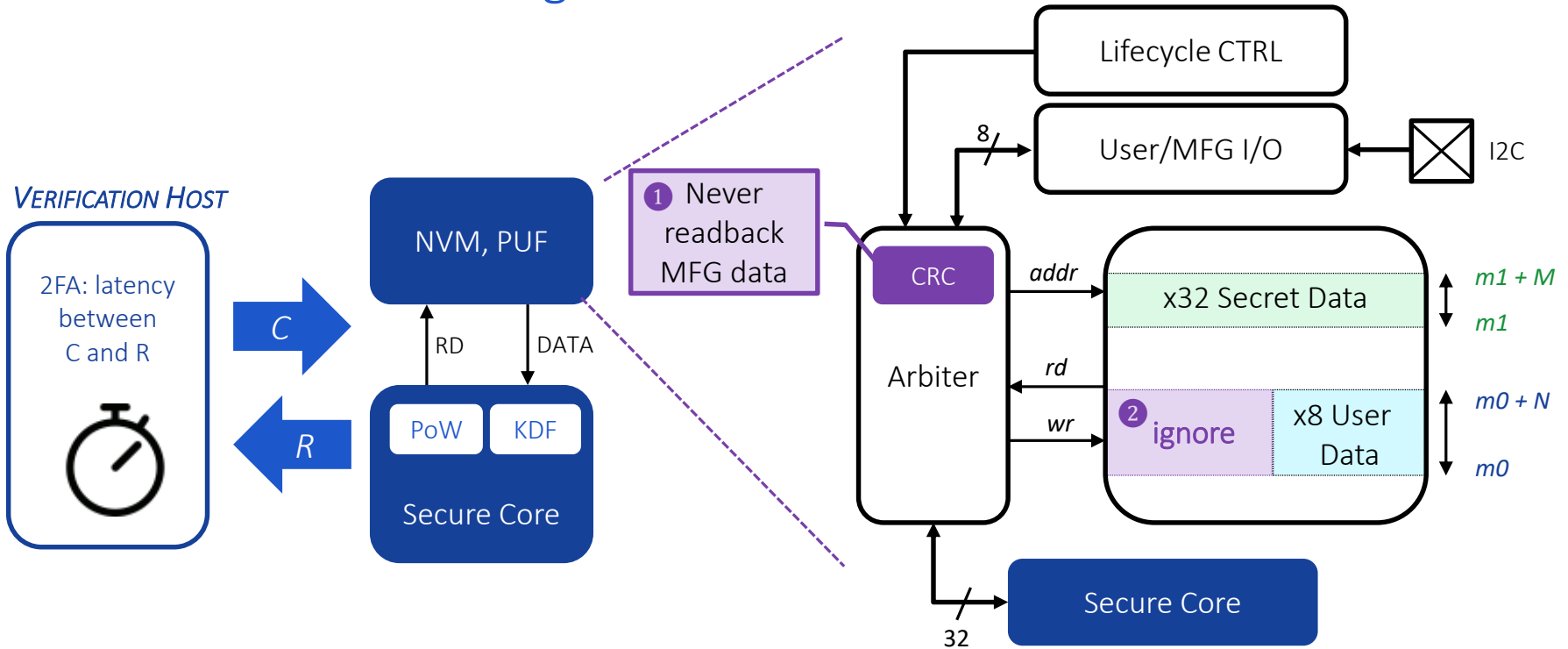
Reverse Talk: NVM has Numerous Attack Surfaces

Forward Talk: Protecting NVM



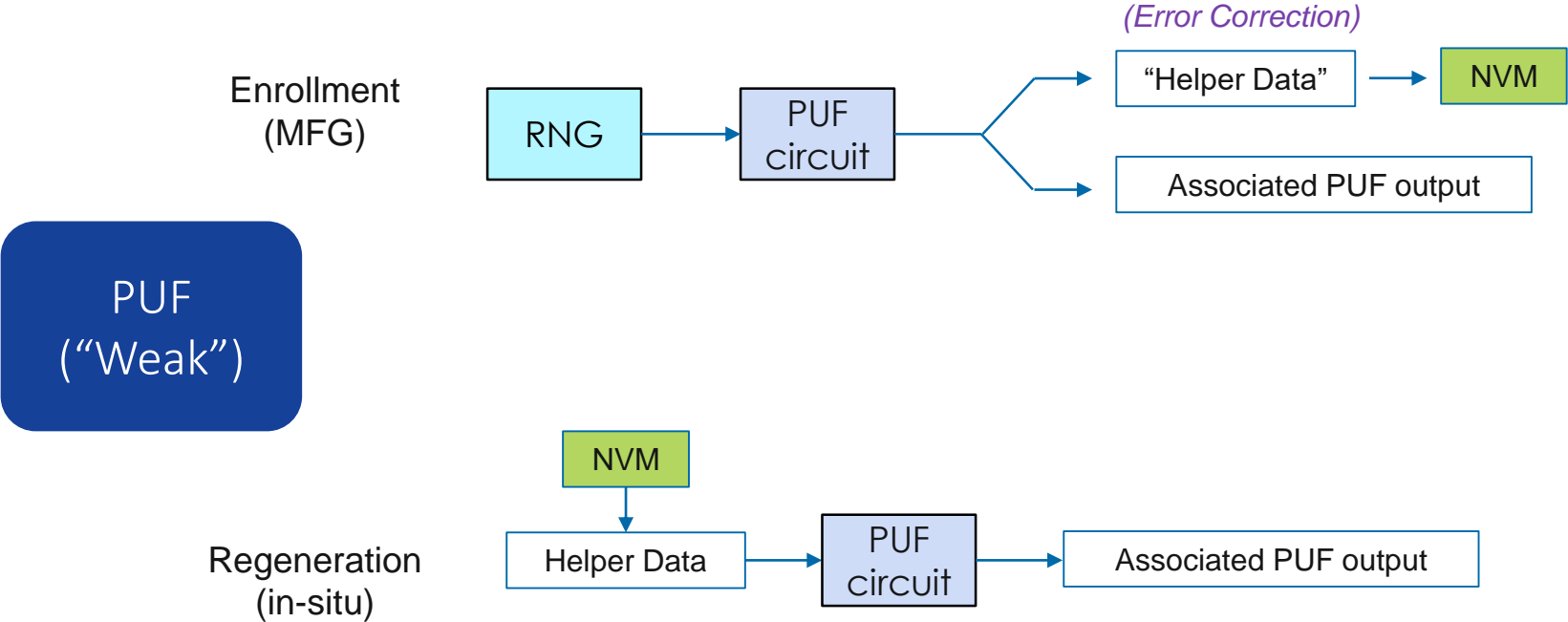
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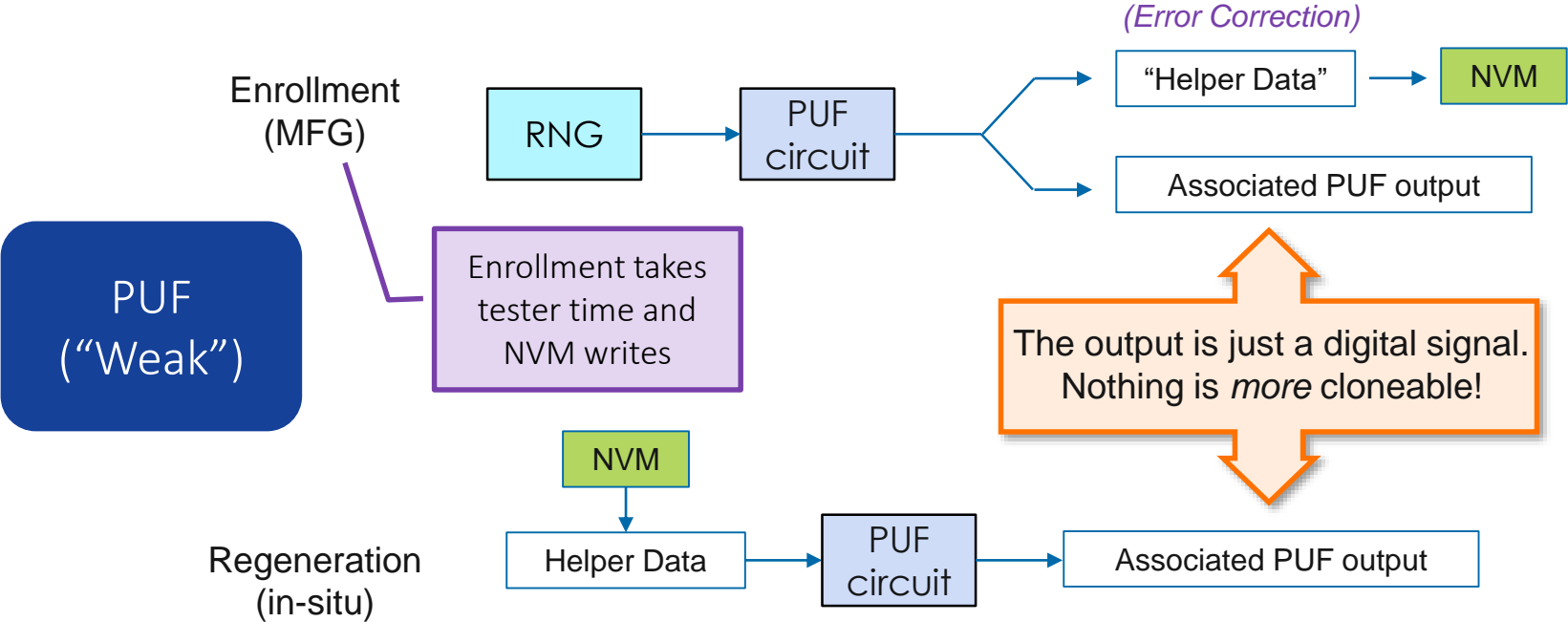
Reverse Talk: NVM has Numerous Attack Surfaces

Forward Talk: PUFs – Physically Unclonable Functions



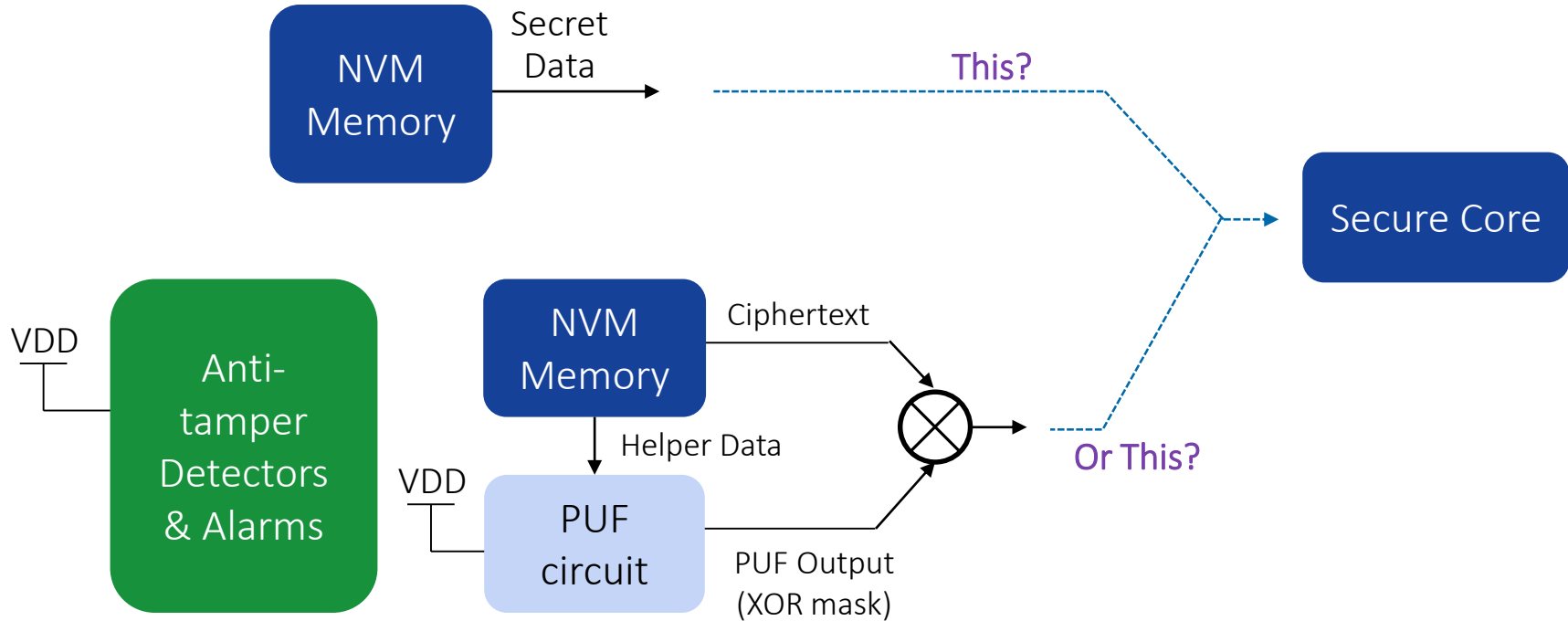
Reverse Talk: Most PUFs are Incorrectly Used

Forward Talk: PUFs – Physically Unclonable Functions



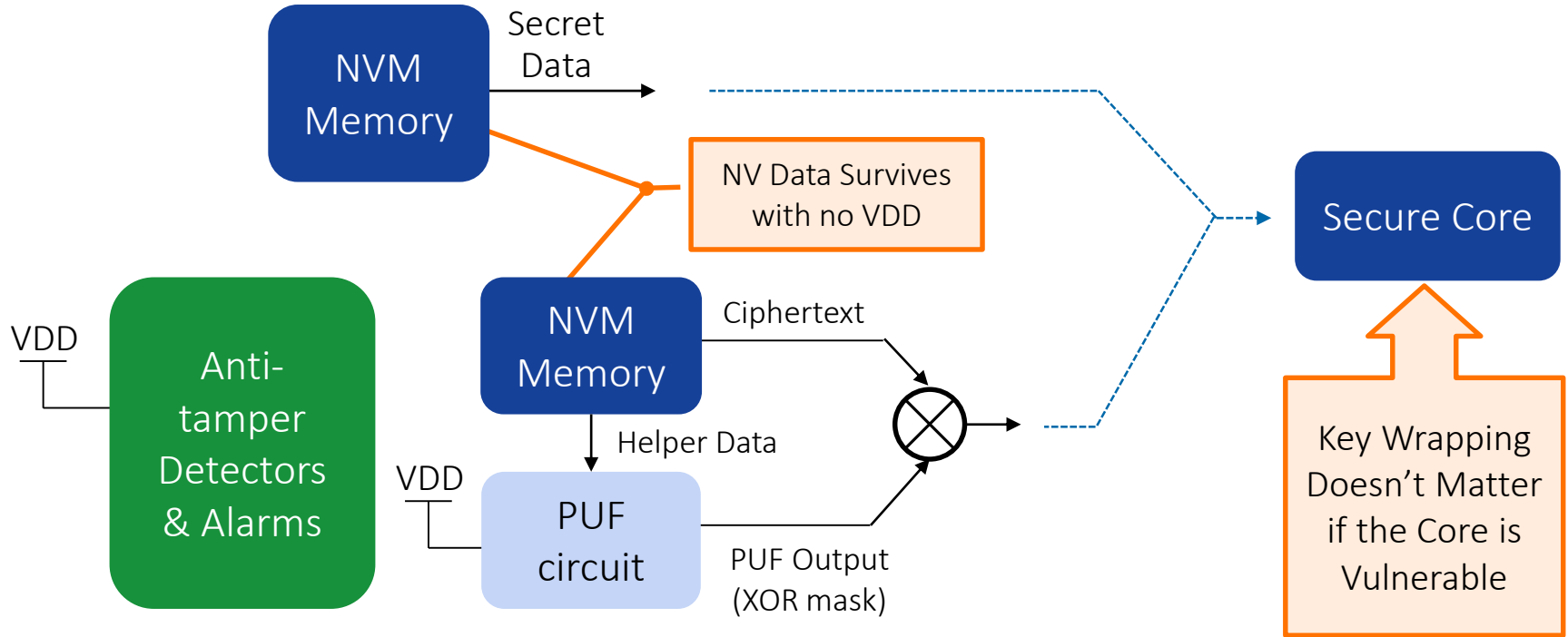
Reverse Talk: Most PUFs are Incorrectly Used

Forward Talk: PUFs – One Way to Use them Well: “Key Wrapping”



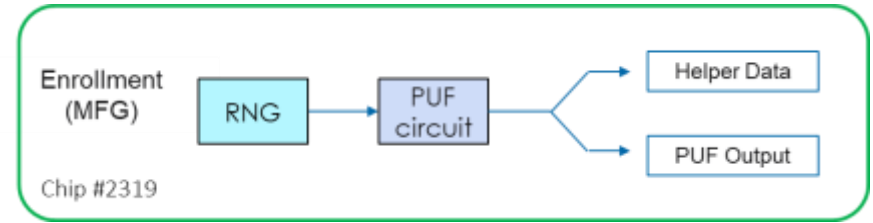
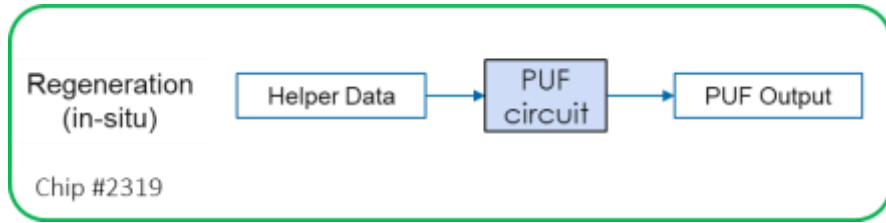
Reverse Talk: Key Wrapping Might Not Matter

Forward Talk: PUFs – One Way to Use them Well: “Key Wrapping”



Reverse Talk: Key Wrapping Might Not Matter

Forward Talk: Backing Up ... What about a PUF is *Actually* Unclonable?

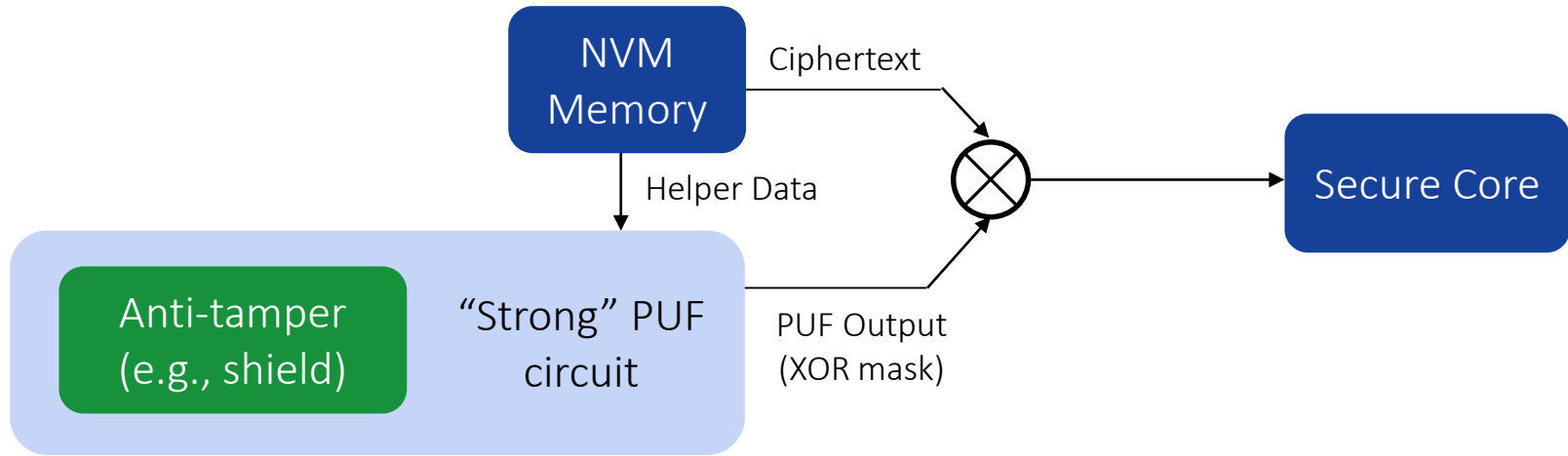


- The PUF Circuit on Chip #2319 is performing a Unique, Unclonable Transformation!
- $\text{PUF_Output}_{\#2319} = f_{\#2319} \{ \text{Helper_Data}_{\#2319} \}$

- Enrollment is a RNG process and can be performed more than once!
- Imagine ten Helper Data images were generated during MFG of Chip #2319...

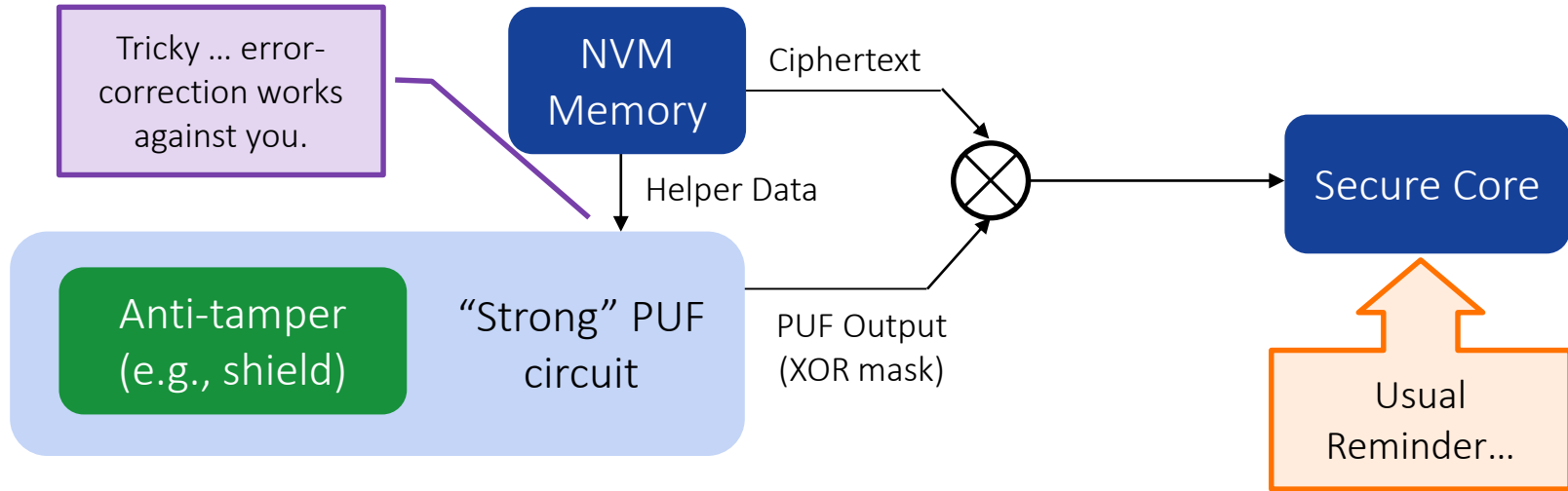
Reverse Talk: Correlation between Helper Data and PUF Output?

Forward Talk: PUFs – Another Use: “Tamper-Evidence”



Reverse Talk: Very Difficult to Detect Very Small Changes Everywhere

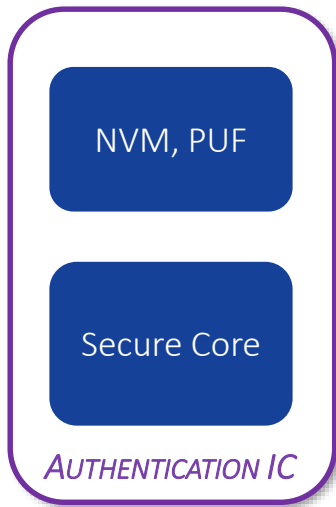
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Reverse Talk: Very Difficult to Detect Very Small Changes Everywhere

Forward Talk: In Conclusion...

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Keep in Mind the Goals:

- Force your opponent to a **full netlist recovery** with lots of FIBs and **manual electrical measurements**
- Force your opponent to **produce custom silicon**, more than an easily programmed MCU

Keep in Mind the Goals:

- Expertise in Firmware, Side-Channel, and Fault: access to at least 25% of \$60B/yr

Attendees, Organizers, Antriksh S.



...Thank you

Questions?

Rambus

Backup

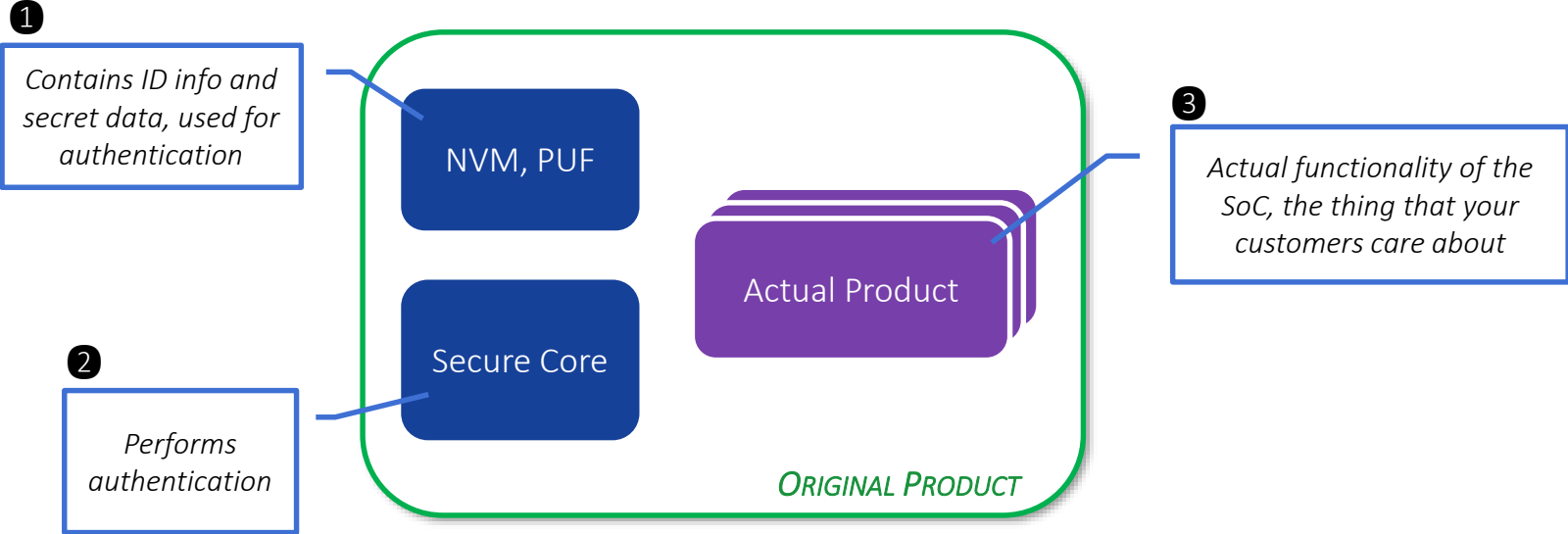


Just In Case

Agenda

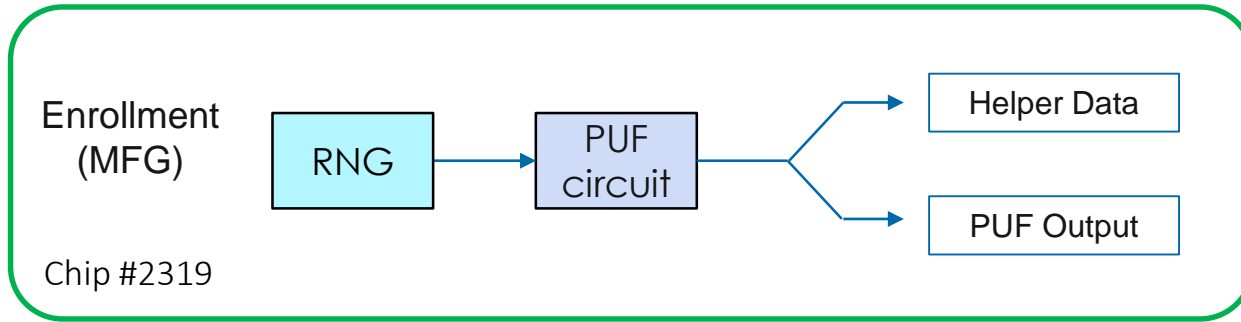
- Introduction to me
- Approach: F.E. Team vs. R.E. Team
 - Motivations (Saturn-V urban legend)
- Adversarial Concept
 - Forward/Reverse
- Manufacturing theft, Provenance Verification
- Product concepts
 - Low-cost MCU
 - Basic challenge-response; provenance verification
- Where are secrets kept?
 - Combo of Netlist, NVM (provisioned), PUF (self-generated)
- How to attack all of those?

Forward Talk: How to prevent Reverse-Engineering



Reverse Talk: How to defeat anti-R.E. countermeasures

Forward Talk: Backing Up ... What in a PUF is *Actually* Unclonable?



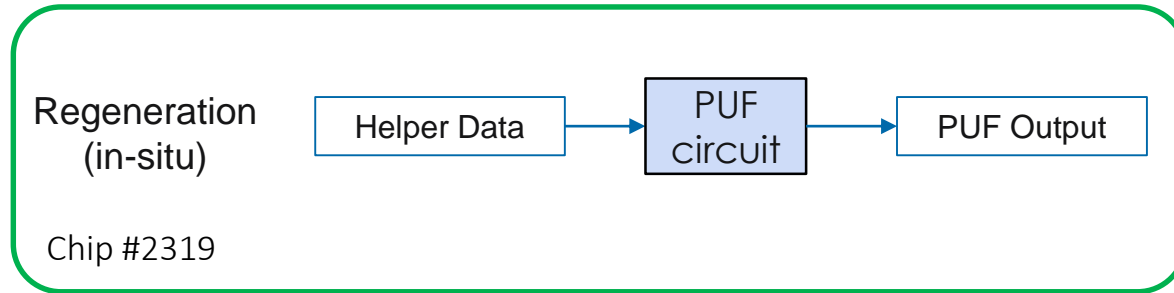
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$$\text{PUF_Output}_{\#2319} = f_{\#2319}(\text{Helper_Data}_{\#2319})$$

- Enrollment is a random process and can be performed more than once!
- Imagine ten Helper Data images were generated during MFG of Chip #2319...

Reverse Talk: Correlation between Helper Data and PUF Output?

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